What is claimed is:

- 2 comprising:
- 3 a step of using laser light emitted from a Q-switched
- 4 mode-locked pulse laser as laser light to be applied for repair
- 5 processing.
- 1 2. The method for repairing the pattern using the laser
- 2 according to Claim 1, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 3. A method for repairing a pattern using a laser
- 2 comprising:
- a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser by using an optical modulator
- 6 and using said laser light having said sliced single pulse or said
- 7 sliced multi-laser pulses as laser light to be applied for repair
- 8 processing.
- 1 4. The method for repairing the pattern using the laser
- 2 according to Claim 3, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 5. The method for repairing the pattern using the laser
- 2 according to Claim 3, wherein the number of said multi-laser pulses

- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.
- 1 6. A method for repairing a pattern using a laser
- 2 comprising:
- a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser by using an optical modulator;
- 6 and
- 7 a step of directly amplifying said laser light having said
- 8 sliced single laser pulse or said sliced multi-laser pulses by
- 9 using an optical amplifier and using said amplified laser light
- 10 as laser light to be applied for repair processing.
- 1 7. The method for repairing the pattern using the laser
- 2 according to Claim 6, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 8. The method for repairing the pattern using the laser
- 2 according to Claim 6, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.
- 9. A method for repairing a pattern using a laser

- 2 comprising:
- 3 a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;
- 6 and
- 7 a step of multiplexing one laser light having a first laser
- 8 pulse obtained by splitting said single laser pulse or said
- 9 multi-laser pulses and an other laser light having a second laser
- 10 pulse obtained by splitting said single laser pulse or said
- 11 multi-laser pulses and by providing time delay to said second laser
- 12 pulse into one laser light and using said multiplexed laser light
- 13 as laser light to be applied for repair processing.
 - 1 10. The method for repairing the pattern using the laser
- 2 according to Claim 9, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 11. The method for repairing the pattern using the laser
- 2 according to Claim 10, wherein said time delay between said first
- 3 laser pulse and said second laser pulse is in a range of 0.1
- 4 nanoseconds to 9 nanoseconds.
- 1 12. The method for repairing the pattern using the laser
- 2 according to Claim 9, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.

- 1 13. A method for repairing a pattern using a laser 2 comprising:
- 3 a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;
- a step of multiplexing one laser light having a first laser
- 7 pulse obtained by splitting said single laser pulse or said
- 8 multi-laser pulses and an other laser light having a second laser
- 9 pulse obtained by splitting said single laser pulse or said
- 10 multi-laser pulses and by providing time delay to said second laser
- 11 pulse into one laser light; and
- a step of directly amplifying said multiplexed laser light
- 13 by using an optical amplifier and using said amplified laser light
- 14 as laser light to be applied for repair processing.
- 1 14. The method for repairing the pattern using the laser
- 2 according to Claim 13, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 15. The method for repairing the pattern using the laser
- 2 according to Claim 13, wherein said time delay between said first
- 3 laser pulse and said second laser pulse is in a range of 0.1
- 4 nanoseconds to 10 nanoseconds.
- 1 16. The method for repairing the pattern using the laser
- 2 according to Claim 13, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser

- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.
- 1 17. A method for repairing a pattern using a laser
- 2 comprising:
- 3 a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;
- 6 and
- 7 a step of converting a wavelength of laser light having said
- 8 sliced single pulse or said sliced multi-laser pulses to produce
- 9 harmonic light and using said harmonic light as laser light to
- 10 be applied for repair processing.
 - 1 18. The method for repairing the pattern using the laser
- 2 according to Claim 178, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 19. The method for repairing the pattern using the laser
- 2 according to Claim 17, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.
- 1 20. A method for repairing a pattern using a laser
- 2 comprising:
- 3 a step of slicing a single laser pulse or multi-laser pulses

- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;
- 6 a step of multiplexing one laser light having a first laser
- 7 pulse obtained by splitting said single laser pulse or said
- 8 multi-laser pulses and an other laser light having a second laser
- 9 pulse obtained by splitting said single laser pulse or said
- 10 multi-laser pulses and by providing time delay to said second laser
- 11 pulse into one laser light; and
- 12 a step of converting a wavelength of said multiplexed laser
- 13 light to produce harmonic light and using said harmonic light as
- 14 laser light to be applied for repair processing.
- 1 21. The method for repairing the pattern using the laser
- 2 according to Claim 20, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- picoseconds to 300 picoseconds.
- 1 22. The method for repairing the pattern using the laser
- 2 according to Claim 20, wherein said time delay between said first
- 3 laser pulse and said second laser pulse is in a range of 0.1
- 4 nanoseconds to 10 nanoseconds.
- 1 23. The method for repairing the pattern using the laser
- 2 according to Claim 20, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.

- 1 24. A method for repairing a pattern using a laser
- 2 comprising:
- 3 a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;
- 6 a step of directly amplifying laser light having said sliced
- 7 single laser pulse or said sliced multi-laser pulses using an
- 8 optical amplifier; and
- 9 a step of converting a wavelength of said amplified laser
- 10 light to produce harmonic light and using said harmonic light as
- 11 laser light to be applied for repair processing.
 - 1 25. The method for repairing the pattern using the laser
- 2 according to Claim 24, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 26. The method for repairing the pattern using the laser
- 2 according to Claim 24, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- $4 \hspace{0.5cm} \texttt{mode-locked pulse laser and time to start slicing said multi-laser} \\$
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.
- 1 27. A method for repairing a pattern using a laser
- 2 comprising:
- a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;

- 6 a step of multiplexing one laser light having a first laser
- 7 pulse obtained by splitting said single laser pulse or said
- 8 multi-laser pulses and an other laser light having a second laser
- 9 pulse obtained by splitting said single laser pulse or said
- 10 multi-laser pulses and by providing time delay to said second laser
- 11 pulse into one laser light;
- a step of directly amplifying said multiplexed laser light
- 13 by using an optical amplifier; and
- a step of converting a wavelength of said amplified laser
- 15 light to produce harmonic light and using said harmonic light as
- 16 laser light to be applied for repair processing.
- 1 28. The method for repairing the pattern using the laser
- 2 according to Claim 27, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 29. The method for repairing the pattern using the laser
- 2 according to Claim 27, wherein said time delay between said first
- 3 laser pulse and said second laser pulse is in a range of 0.1
- 4 nanoseconds to 10 nanoseconds.
- 1 30. The method for repairing the pattern using the laser
- 2 according to Claim 27, wherein the number of said multi-laser pulses
- 3 to be sliced from said laser light emitted from said Q-switched
- 4 mode-locked pulse laser and time to start slicing said multi-laser
- 5 pulses to obtain a first pulse are able to be set in an arbitrary
- 6 manner.

- 1 31. A method for repairing a pattern using a laser 2 comprising:
- 3 a step of slicing a single laser pulse or multi-laser pulses
- 4 from a string of pulses making up laser light emitted from a
- 5 Q-switched mode-locked pulse laser using an optical modulator;
- 6 a step of directly amplifying laser light having said sliced
- 7 single laser pulse or sliced multi-laser pulse by using an optical
- 8 amplifier;
- 9 a step of multiplexing one amplified laser light having a
- 10 first laser pulse obtained by splitting said single laser pulse
- 11 or said multi-laser pulses and an other amplified laser light having
- 12 a second laser pulse obtained by splitting said single laser pulse
- 13 or said multi-laser pulses and by providing time delay to said
- 14 second laser pulse into one laser light;
- a step of directly amplifying said multiplexed laser light
- 16 by using an optical amplifier; and
- a step of converting a wavelength of said amplified laser
- 18 light to produce harmonic light and using said harmonic light as
- 19 laser light to be applied for repair processing.
- 1 32. The method for repairing the pattern using the laser
- 2 according to Claim 31, wherein a pulse width of said laser light
- 3 to be applied for said repair processing is in a range of 10
- 4 picoseconds to 300 picoseconds.
- 1 33. The method for repairing the pattern using the laser
- 2 according to Claim 31, wherein said time delay between said first
- 3 laser pulse and said second laser pulse is in a range of 0.1
- 4 nanoseconds to 10 nanoseconds.

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manner.

- 34. The method for repairing the pattern using the laser according to Claim 31, wherein the number of said multi-laser pulses to be sliced from said laser light emitted from said Q-switched mode-locked pulse laser and time to start slicing said multi-laser pulses to obtain a first pulse are able to be set in an arbitrary
- 35. A laser-based pattern repair apparatus comprising:

 a Q-switched mode-locked pulse laser to emit laser light

 to be applied for repair processing.
 - 36. The laser-based pattern repair apparatus according to Claim 35, wherein said Q-switched mode-locked pulse laser is made up of a laser resonator having a semiconductor laser pumping unit or a lamp pumping unit, a laser medium including any one of a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic Q-switching element to produce Q-switched pulses, an ultrasonic mode-locker to produce mode-locked pulses, and etalon plates used to select a longitudinal mode of said laser resonator.
- The laser-based pattern repair apparatus according to Claim 36, wherein said laser resonator is provided therein with a plurality of etalon plates each having a different thickness and a remote controller for operating said etalon plates, whereby said etalon plates each having said different thickness are changeably inserted into said laser resonator and disposed on a optical axis thereof.
- 1 38. The laser-based pattern repair apparatus according

- 2 to Claim 37, wherein a variable range of a pulse width of laser
- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 39. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser; and
- 6 wherein laser light emitted from said optical modulator is used
- 7 as laser light to be applied for repair processing.
- 1 40. The laser-based pattern repair apparatus according
- 2 to Claim 39, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping
- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 41. The laser-based pattern repair apparatus according
- 2 to Claim 40, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.

- 1 42. The laser-based pattern repair apparatus according
- 2 to Claim 41, wherein a variable range of a pulse width of laser
- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 43. The laser-based pattern repair apparatus according
- 2 to Claim 39, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 44. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- 6 an optical amplifier to directly amplify laser light having
- 7 said sliced single laser pulse or said sliced multi-laser pulses
- 8 emitted from said optical modulator; and
- 9 wherein laser light emitted from said optical amplifier is
- 10 used as laser light to be applied for repair processing.
 - 1 45. The laser-based pattern repair apparatus according
- 2 to Claim 44, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping
- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic

- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 46. The laser-based pattern repair apparatus according
- 2 to Claim 45, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- 1 47. The laser-based pattern repair apparatus according
- 2 to Claim 46, wherein a variable range of a pulse width of laser
- 3 light that is able to be obtained by switching for inserting said
- $_{
 m I}$ etalon plates is 10 picoseconds to 300 picoseconds.
- 1 48. The laser-based pattern repair apparatus according
- 2 to Claim 44, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 49. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- a laser pulse multiplexing and delaying unit to multiplex

- 7 one amplified laser light having a first laser pulse obtained by
- 8 splitting said single laser pulse or said multi-laser pulses and
- 9 an other amplified laser light having a second laser pulse obtained
- 10 by splitting said single laser pulse or said multi-laser pulses
- 11 and by providing time delay to said second laser pulse into one
- 12 laser light; and
- wherein laser light emitted from said laser pulse
- 14 multiplexing and delaying unit is used as laser light to be applied
- 15 for repair processing.
 - 1 50. The laser-based pattern repair apparatus according
 - 2 to Claim 49, wherein said Q-switched mode-locked pulse laser is
 - 3 made up of a laser resonator having a semiconductor laser pumping
 - 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 51. The laser-based pattern repair apparatus according
- 2 to Claim 50, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- 1 52. The laser-based pattern repair apparatus according
- 2 to Claim 51, wherein a variable range of a pulse width of laser

- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 53. The laser-based pattern repair apparatus according
- 2 to Claim 49, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 54. The laser-based pattern repair apparatus according
- 2 to Claim 49, wherein said laser pulse multiplexing and delaying
- 3 unit is able to change said delay time within a range of 0.1
- 4 nanoseconds to 10 nanoseconds and said change of said delay time
- 5 is able to be implemented by remote control.
- 1 55. The laser-based pattern repair apparatus according
- 2 to Claim 49, wherein an intensity of a peak power of said first
- 3 laser pulse and said second laser pulse to be multiplexed and delayed
- 4 by said laser pulse multiplexing and delaying unit is able to be
- 5 controlled and calibrated by remote control.
- 1 56. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- a laser pulse multiplexing and delaying unit to multiplex
- 7 one amplified laser light having a first laser pulse obtained by

- 8 splitting said single laser pulse or said multi-laser pulses and
- 9 an other amplified laser light having a second laser pulse obtained
- 10 by splitting said single laser pulse or said multi-laser pulses
- 11 and by providing time delay to said second laser pulse into one
- 12 laser light;
- an optical amplifier to directly amplify said multiplexed
- 14 laser light; and
- wherein laser light emitted from said optical amplifier is
- 16 used as laser light to be applied for repair processing.
 - 1 57. The laser-based pattern repair apparatus according
 - 2 to Claim 56, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping
- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 58. The laser-based pattern repair apparatus according
- 2 to Claim 57, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- 1 59. The laser-based pattern repair apparatus according
- 2 to Claim 58, wherein a variable range of a pulse width of laser

- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 60. The laser-based pattern repair apparatus according
- 2 to Claim 56, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 61. The laser-based pattern repair apparatus according
- 2 to Claim 56, wherein said laser pulse multiplexing and delaying
- 3 unit is able to change said delay time within a range of 0.1
 - nanoseconds to 10 nanoseconds and said change of said delay time
- 5 is able to be implemented by remote control.
- 1 62. The laser-based pattern repair apparatus according
- 2 to Claim 56, wherein an intensity of a peak power of said first
- 3 laser pulse and said second laser pulse to be multiplexed and delayed
- 4 by said laser pulse multiplexing and delaying unit is able to be
- 5 controlled and calibrated by remote control.
- 1 63. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- 6 a wavelength converting unit to convert a wavelength of laser
- 7 light having said sliced single pulse or said sliced multi-laser

- 8 pulses to produce harmonic light; and
- 9 wherein laser light emitted from said wavelength converting
- 10 unit is used as laser light to be applied for repair processing.
- 1 64. The laser-based pattern repair apparatus according
- 2 to Claim 63, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping
- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 65. The laser-based pattern repair apparatus according
- 2 to Claim 64, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- 1 66. The laser-based pattern repair apparatus according
- 2 to Claim 65, wherein a variable range of a pulse width of laser
- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 67. The laser-based pattern repair apparatus according
- 2 to Claim 63, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said

- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 68. The laser-based pattern repair apparatus according
- 2 to Claim 63, wherein said wavelength converting unit is a wavelength
- 3 converting element using a nonlinear optical crystal to emit a
- 4 third harmonic, fourth harmonic, and fifth harmonic each having
- 5 a wavelength of not more than 360 nm.
- 1 69. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- 6 a laser pulse multiplexing and delaying unit to multiplex
- 7 one laser light having a first laser pulse obtained by splitting
- 8 said single laser pulse or said multi-laser pulses and an other
- 9 laser light having a second laser pulse obtained by splitting said
- 10 single laser pulse or said multi-laser pulses and by providing
- 11 time delay to said second laser pulse into one laser light;
- 12 a wavelength converting unit to convert a wavelength of said
- 13 multiplexed laser light to produce harmonic light; and
- wherein laser light emitted from said wavelength converting
- 15 unit is used as laser light to be applied for repair processing.
 - 1 70. The laser-based pattern repair apparatus according
- 2 to Claim 69, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping

- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 71. The laser-based pattern repair apparatus according
- 2 to Claim 70, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- The laser-based pattern repair apparatus according
- 2 to Claim 71, wherein a variable range of a pulse width of laser
- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 73. The laser-based pattern repair apparatus according
- 2 to Claim 69, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 74. The laser-based pattern repair apparatus according
- 2 to Claim 69, wherein said laser pulse multiplexing and delaying
- 3 unit is able to change said delay time within a range of 0.1

- 4 nanoseconds to 10 nanoseconds and said change of said delay time
- 5 is able to be implemented by remote control.
- The laser-based pattern repair apparatus according
- 2 to Claim 69, wherein an intensity of a peak power of said first
- 3 laser pulse and said second laser pulse to be multiplexed and delayed
- 4 by said laser pulse multiplexing and delaying unit is able to be
- 5 controlled and calibrated by remote control.
- 1 76. The laser-based pattern repair apparatus according
- 2 to Claim 69, wherein said wavelength converting unit is a wavelength
- 3 converting element using a nonlinear optical crystal to emit a
- 4 third harmonic, fourth harmonic, and fifth harmonic each having
- 5 a wavelength of not more than 360 nm.
- 1 77. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- 6 an optical amplifier to directly amplify said laser light
- 7 having said sliced single laser pulse or said sliced multi-laser
- 8 pulses;
- 9 a wavelength converting unit to convert a wavelength of laser
- 10 light emitted from said optical amplifier to produce harmonic
- 11 light; and
- wherein laser light emitted from said wavelength converting
- 13 unit is used as laser light to be applied for repair processing.

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optical axis thereof.

The laser-based pattern repair apparatus according to Claim 77, wherein said Q-switched mode-locked pulse laser is made up of a laser resonator having a semiconductor laser pumping unit or a lamp pumping unit, a laser medium including any one of a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic Q-switching element to produce Q-switched pulses, an ultrasonic

mode-locker to produce mode-locked pulses, and etalon plates used

to select a longitudinal mode of said laser resonator.

- 79. The laser-based pattern repair apparatus according to Claim 78, wherein said laser resonator is provided therein with a plurality of etalon plates each having a different thickness and a remote controller for operating said etalon plates, whereby said etalon plates each having said different thickness are changeably inserted into said laser resonator and disposed on a
- 1 80. The laser-based pattern repair apparatus according 2 to Claim 79, wherein a variable range of a pulse width of laser 3 light that is able to be obtained by switching for inserting said 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 81. The laser-based pattern repair apparatus according 2 to Claim 77, wherein, when said multi-laser pulses are sliced by 3 said optical modulator from laser light emitted from said 4 Q-switched mode-locked pulse laser, the number of said multi-laser 5 pulses to be sliced and time to start slicing a first pulse are 6 able to be arbitrarily set and to be operated by remote control.

- 1 82. The laser-based pattern repair apparatus according
- 2 to Claim 77, wherein said wavelength converting unit is a wavelength
- 3 converting element using a nonlinear optical crystal to emit a
- 4 third harmonic, fourth harmonic, and fifth harmonic each having
- 5 a wavelength of not more than 360 nm.
- 1 83. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- a laser pulse multiplexing and delaying unit to multiplex
- 7 one laser light having a first laser pulse obtained by splitting
- 8 said sliced single laser pulse or said sliced multi-laser pulses
- 9 and an other laser light having a second laser pulse obtained
- 10 by splitting said sliced single laser pulse or said sliced
- 11 multi-laser pulses and by providing time delay to said second laser
- 12 pulse into one laser light;
- an optical amplifier to directly amplify said multiplexed
- 14 laser light;
- 15 a wavelength converting unit to convert a wavelength of laser
- 16 light emitted from said optical amplifier to produce harmonic
- 17 light; and
- wherein laser light emitted from said wavelength converting
- unit is used as laser light to be applied for repair processing.
 - 1 84. The laser-based pattern repair apparatus according
- 2 to Claim 83, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping

- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 85. The laser-based pattern repair apparatus according
- 2 to Claim 84, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- 1 86. The laser-based pattern repair apparatus according
- 2 to Claim 85, wherein a variable range of a pulse width of laser
- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 87. The laser-based pattern repair apparatus according
- 2 to Claim 83, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 88. The laser-based pattern repair apparatus according
- 2 to Claim 83, wherein said laser pulse multiplexing and delaying
- 3 unit is able to change said delay time within a range of 0.1

- 4 nanoseconds to 10 nanoseconds and said change of said delay time
- 5 is able to be implemented by remote control.
- 1 89. The laser-based pattern repair apparatus according
- 2 to Claim 83, wherein an intensity of a peak power of said first
- 3 laser pulse and said second laser pulse to be multiplexed and delayed
- 4 by said laser pulse multiplexing and delaying unit is able to be
- 5 controlled and calibrated by remote control.
- 1 90. The laser-based pattern repair apparatus according
- 2 to Claim 83, wherein said wavelength converting unit is a wavelength
- 3 converting element using a nonlinear optical crystal to emit a
- 4 third harmonic, fourth harmonic, and fifth harmonic each having
- 5 a wavelength of not more than 360 nm.
- 1 91. A laser-based pattern repair apparatus comprising:
- 2 a Q-switched mode-locked pulse laser;
- 3 an optical modulator to slice a single laser pulse or
- 4 multi-laser pulses from a string of pulses contained in laser light
- 5 emitted from said Q-switched mode-locked pulse laser;
- a laser pulse multiplexing, delaying, and amplifying unit
- 7 to multiplex one laser light having a first laser pulse obtained
- 8 by splitting said sliced single laser pulse or said sliced
- 9 multi-laser pulses and an other amplified laser light having a
- 10 second laser pulse obtained by splitting said sliced single laser
- 11 pulse or said sliced multi-laser pulses and by providing time delay
- 12 to said second laser pulse into one laser light and, at the same
- 13 time, to directly amplify laser light having said first laser pulse
- 14 by a double pass method in which said laser light is transmitted

- 15 twice through an optical amplifying medium in a reciprocating
- 16 manner and to directly amplify laser light having said second laser
- 17 pulseby a single pass method in which said laser light is transmitted
- 18 once through said optical amplifying medium;
- 19 a wavelength converting unit to convert a wavelength of laser
- 20 light emitted from said laser pulse multiplexing, delaying, and
- 21 amplifying unit to produce harmonic light; and
- 22 wherein laser light emitted from said wavelength converting
- 23 unit is used as laser light to be applied for repair processing.
 - 1 92. The laser-based pattern repair apparatus according
 - 2 to Claim 91, wherein said Q-switched mode-locked pulse laser is
- 3 made up of a laser resonator having a semiconductor laser pumping
- 4 unit or a lamp pumping unit, a laser medium including any one of
- 5 a Nd:YLF laser, Nd:YAG laser and Nd:glass laser, an ultrasonic
- 6 Q-switching element to produce Q-switched pulses, an ultrasonic
- 7 mode-locker to produce mode-locked pulses, and etalon plates used
- 8 to select a longitudinal mode of said laser resonator.
- 1 93. The laser-based pattern repair apparatus according
- 2 to Claim 92, wherein said laser resonator is provided therein with
- 3 a plurality of etalon plates each having a different thickness
- 4 and a remote controller for operating said etalon plates, whereby
- 5 said etalon plates each having said different thickness are
- 6 changeably inserted into said laser resonator and disposed on a
- 7 optical axis thereof.
- 1 94. The laser-based pattern repair apparatus according
- 2 to Claim 93, wherein a variable range of a pulse width of laser

- 3 light that is able to be obtained by switching for inserting said
- 4 etalon plates is 10 picoseconds to 300 picoseconds.
- 1 95. The laser-based pattern repair apparatus according
- 2 to Claim 91, wherein, when said multi-laser pulses are sliced by
- 3 said optical modulator from laser light emitted from said
- 4 Q-switched mode-locked pulse laser, the number of said multi-laser
- 5 pulses to be sliced and time to start slicing a first pulse are
- 6 able to be arbitrarily set and to be operated by remote control.
- 1 96. The laser-based pattern repair apparatus according
- 2 to Claim 91, wherein said laser pulse multiplexing, delaying, and
- 3 amplifying unit is able to change said delay time within a range
 - of 0.1 nanoseconds to 10 nanoseconds and said change of said delay
- 5 time is able to be implemented by remote control.
- 1 97. The laser-based pattern repair apparatus according
- 2 to Claim 91, wherein an intensity of a peak power of said first
- 3 laser pulse and said second laser pulse to be multiplexed and delayed
- 4 by said laser pulse multiplexing and delaying unit; or multiplexed,
- 5 delayed, and amplified by said laser pulse multiplexing, delaying,
- 6 and amplifying unit is able to be controlled and calibrated by
- 7 remote control.
- 1 98. The laser-based pattern repair apparatus according
- 2 to Claim 91, wherein said wavelength converting unit is a wavelength
- 3 converting element using a nonlinear optical crystal to emit a
- 4 third harmonic, fourth harmonic, and fifth harmonic each having
- 5 a wavelength of not more than 360 nm.